



Mechanically Pumped Fluid Loops for Spacecraft Thermal Control: Past, Present & Future

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- Fundamental Requirements for Thermal Control of Robotic Spacecraft & Instruments
- Traditional Methods for Thermal Control of Spacecraft
- What is a Mechanically Pumped Fluid Loop?
- Why Use a Pumped Fluid Loop for Thermal Control?
- Fundamental Physics of Pumped Fluid Loops
- Basic Architecture
- History
- Working Fluids
- Characteristics of Pumped Loop Components
- Leaks, Leaks, Leaks
- Compatibility of Fluids and Wetted Materials
- Development Tests
- Other Considerations





- Case Study: Mars Pathfinder, MPF (*Past*)
- Mars Exploration Rover, MER (*Present*)
- Mars Science Laboratory, MSL (*Future*)
- Next Generation Loops
- Summary





- Primary Goal: Maintain temperatures of all components within their allowable limits with minimal complexity, maximum reliability and minimal use of resources like electrical power and mass
- All components are thermally connected to space via the internals of the spacecraft
- If one is trying to reject heat:
 - Pick up heat from heat sources and <u>eventually</u> reject it to space via radiation
 - Radiation to space is the only heat loss mechanism due to lack of an atmosphere
- If one is trying to conserve heat:
 - Insulate the heat sources from the heat sink (use insulation)
- If one is trying to supply heat:
 - Pick up heat from heat sources and *eventually* insert it to the component
- The <u>designing</u> and <u>controlling</u> of this <u>connection</u> to achieve temperature levels within each component that satisfy their allowable limits is one of the most important aspects of thermal control of spacecraft





- Typical Allowable Flight Temperatures
 - Electronics: -40/50C
 - Battery: -20/30C
 - Actuators: -55/25C (Operating)
 - -105/40C (non-operating)
 - Propulsion Tanks: 15/30C
 - Propulsion lines: 15/50C
 - Thruster Valve: 20/110C (operate), 20/50C (non-operate)





- Typical thermal control methods rely on a *passive connection* between innards of the spacecraft and space
- Passive couplings could be conductive or radiative
 - Examples of conductive coupling:
 - S/C metallic structure from electronics to radiator
 - Examples of radiative coupling:
 - High emissivity thermal control paints, tapes
- Passive isolations could be conductive or radiative
 - Examples of conductive isolation:
 - Non-metallic structure (fiberglass isolators) from electronics to radiator
 - Examples of radiative isolation:
 - Low emissivity thermal control paints, tapes, Multi-Layer insulation (MLI)
- Louvers are radiative means to achieve variable emissivity passively
 - Very sensitive to solar exposure and heavy
- Heat pipes are "semi-passive' means to connect components to space
 - Use liquid-vapor phase change to transport heat
 - Superior to ordinary conductors
 - Can be used to condcut or isolate (Variable conductance heat pipe)
 - Very sensitive to gravity and tilt
 - Very hard to test in 1-g for complex 3-D geometries



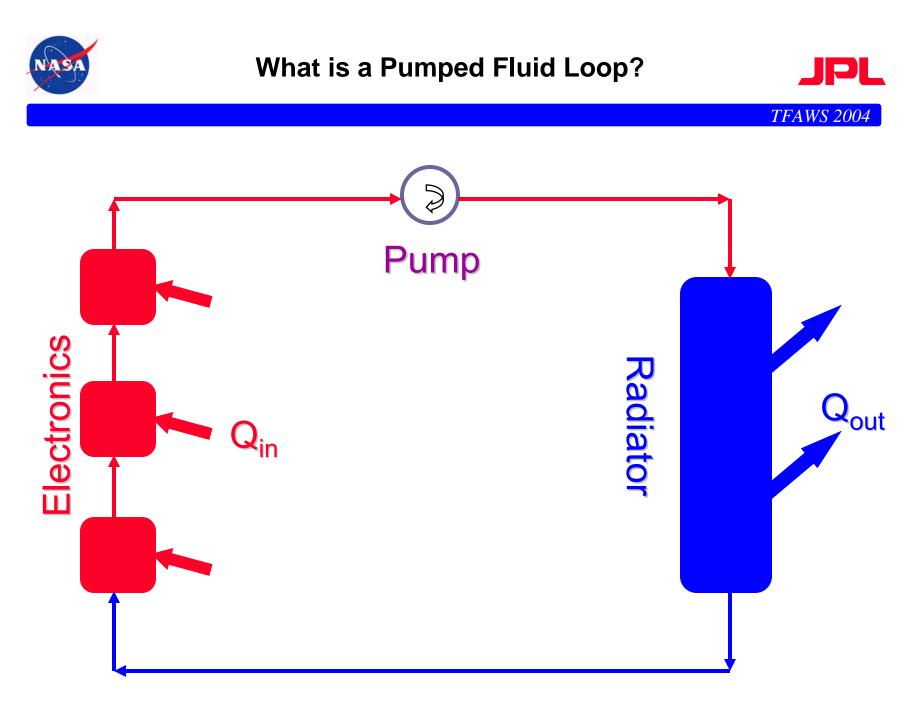


- Active means of achieving variable connections
 - Heat Switches
 - Heavy and low heat flow capacity
- Active means of supplying/removing heat for T/C
 - Heaters
 - Thermostats
 - Thermoelectric coolers





		<u>Launch</u>	<u>Cruise</u>	EDL	<u>Surface</u>
•	Viking -	Fairing purge Cooling	Passive Radiative	Passive Thermal cap.	Passive Heat switch
•	Mars Pathfinder -	Fairing purge Cooling w/HRS	Active HRS loop	Passive Thermal cap.	Passive Thermal cap.
•	Mars Polar Lander -	Fairing purge Cooling	Passive Radiative	Passive Thermal Cap.	Passive Thermal cap
•	MER rover -	Fairing purge Cooling w/HRS	Active HRS loop	Passive Thermal Cap.	Passive Heat switch
•	MSL '09 -	Fairing purge Cooling w/HRS	Active 2 HRS loops	Passive Thermal Cap.	Passive/active? LHP/pump?



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• The key difference between traditional means of T/C and the use of mechanically pumped fluid loops lies in the *connection* between the *thermally controlled components* and the *heat loss surface* (radiator)

- The connection is *convective* instead of *conductive* or *radiative*
- Fluid flowing through tubes connected to the two sets of surfaces (source/sink) convectively picks up heat (source) and dissipates it (sink)
- A mechanical pump is the prime mover of the fluid

• This is the closest one comes to a true THERMAL BUS where we can BOTH pick-up and reject heat simultaneously and automatically at multiple locations

• Until now only single phase fluid flow using liquid has been tried for interplanetary spacecraft

- Future missions could used two phase flow for higher watt densities
 - Use liquid-vapor phase change within heat source
 - Condense vapor in heat sink

Pradeep Bhand Use liquid (only) within pump to create pressure difference





• Mechanically Pumped Fluid Loops (MPFL) are most useful for spacecraft thermal control when heat pickup/rejection capacity, control of this capacity, testability and/or mechanical integration are driving factors

 Advantages when compared with traditional spacecraft thermal control technologies:

- Scalability of heat rejection capacity
- Ability to accept and reject heat at multiple locations
- Flexibility in locating heat dissipating equipment
- Adaptability to late changes in spacecraft design

• Limited use in robotic space missions over the past 30 years due to reliability concerns, but are increasingly being looked at to solve complex thermal control problems





PROS:

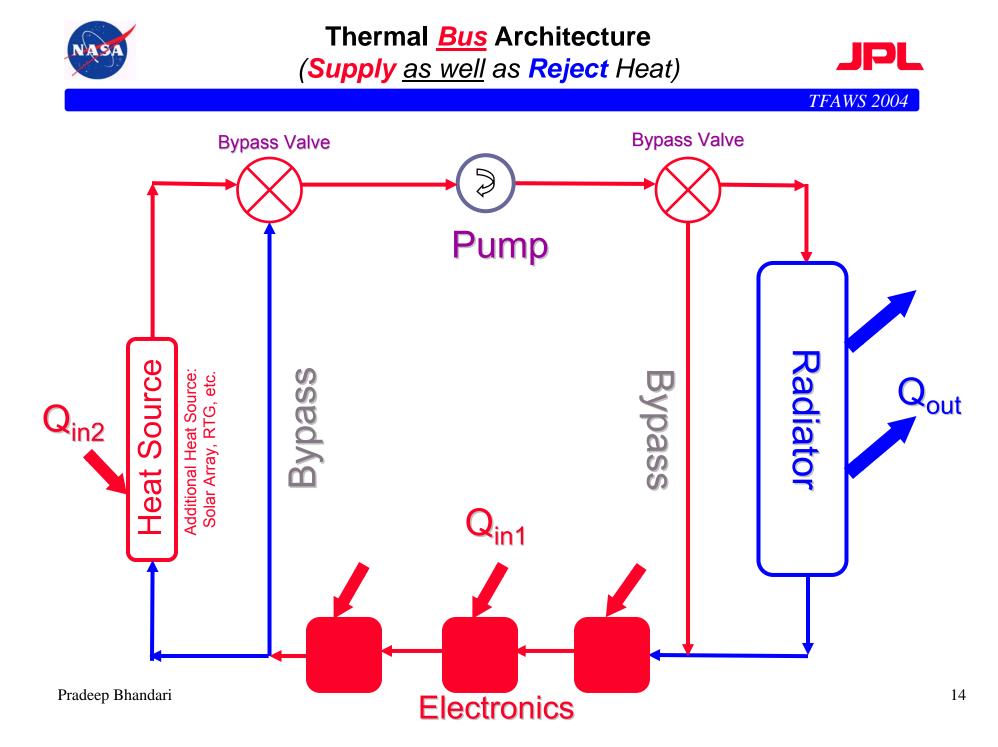
- Integration flexibility Easily adaptable to previously defined geometrical configuration
- Predictablity Thermal and hydraulic analysis is very simple and predictable
- Testability Ground testing is very easy and performance can be easily fine tuned
- Robustness and Controllability Very tight temperature control (few deg. C) of remotely located components possible with widely varying power dissipation and thermal environment
- Heat fluxes Can handle high local fluxes (e.g., electronic components; ~ 3 W/in length of 1/4" dia. fluid tubing)
- **Isothermality -** Small ΔT between source and sink (electronics and radiator)
- Thermal switchability Valving, turning off pump or venting working fluid provides reversible/irreversible switching
- Deployability Using flexible tubing (e.g., Teflon flex lines)
- **Resource usage -** Compact, light, cheap and low power usage
- Versatility Can be used for a variety of diverse missions





POSSIBLE CONS and Preventive Measures:

- Any of the following causes could lead to partial or complete failure of the thermal control system
 - Leaks Leaks through mechanical joints or corrosion of tubing/components
 - · Use well qualified fittings
 - > Vibration/thermal
 - > Accumulator sized to accommodate nominal leak rates
 - Pump failure Long term operation of pumps could degrade their performance or lead to their complete failure
 - · Use redundant pumps
 - Clogged filter Filters used to guard small passages in pumps against particles could clog
 - · Use well qualified and sized filters
 - · Use check valves to automatically bypass filter in flight





Basic Architecture



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THERMAL Pump VALVE **Assembly** ACCUMULATOR P/M CHECK PUMP/ VALVE MOTOR INLET FILTER **BYPAS** Φ P/M € **FILL PORT PURGE PORT BYPASS** Ô OUTLET **Electronics CRUISE RADIATOR FLOW PATH INTERNAL TO FLOW PATH EXTERNAL TO Pump Assembly Pump Assembly**

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- The Fundamental Physics is Really very Simple!!
 - Barely need an undergraduate degree to design it!
 - Hardly need a sophisticated computer model
 - · Hand calculator will suffice
 - Loop Pressure drop: $\Delta P = \Sigma f(L/D)\rho V^2/2$
 - Flow Heat transfer coeff. = (k/D)0.023Re^{0.8}Pr^{0.33}
 - Heat Pickup
 - Aluminum facesheet (component interface)
 - Use simple fin efficiency to estimate delta-T from tube surface
 - Heat Rejection
 - Radiator
 - $Q = mC_p \Delta T = AF \epsilon \sigma (T^4 T_s^4)$ for fluid temp. drop (high rad. flow, hot cases)
 - Use Radiant fin equation for sizing thickness
 - Radiant fluid heat exchanger eqn. for low rad. flow (cold cases)
- Most of the effort goes into engineering and qualifying the system to be reliable and robust





- Mars Pathfinder (JPL, 1996) was the 1st Interplanetary Spacecraft to use a mechanically pumped cooling loop for thermal control during cruise
- Mars Exploration Rover (JPL, 2004) used a similar design adapted to its configuration, also during cruise
- Mars Science Laboratory (JPL, 2009) has base-lined two mechanical loops for thermal control
 - During cruise to cool the Radioisotope Thermo-Electric Generator (RTG) which generates 2000 Watts of heat
 - For thermal control of the rover
 - For both heating and cooling
 - Harvests up waste heat from the RTG for cold conditions
 - Uses radiators to maintain rovers temperatures during hot conditions
 - 1st instance of using pumped fluid loop as a <u>Thermal Bus</u> to supply as well as *pick-up* heat from electronics



Mechanically Pumped Fluid Loop for Robotic Missions



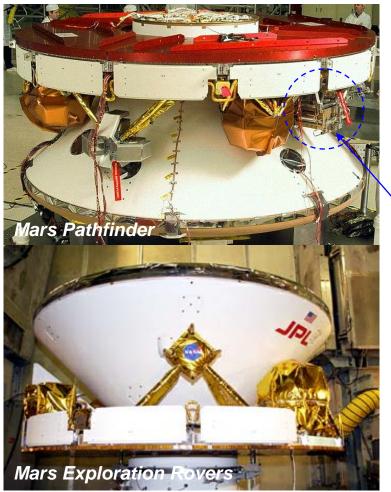
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• MPFLs on robotic missions require low power, low mass, and high reliability pumps

• MPFLs with CFC-11 as the working fluid have flown on Mars Pathfinder (1996) and both Mars Exploration Rover (2003) missions

• MPFL was used to cool the Rover/Lander electronics (150 W) inside the Aeroshell during the seven month cruise to Mars

• The pump was qualified for -30 to +40°C and operated near +10°C. The CFC-11 working fluid ranged from -80 to +20°C

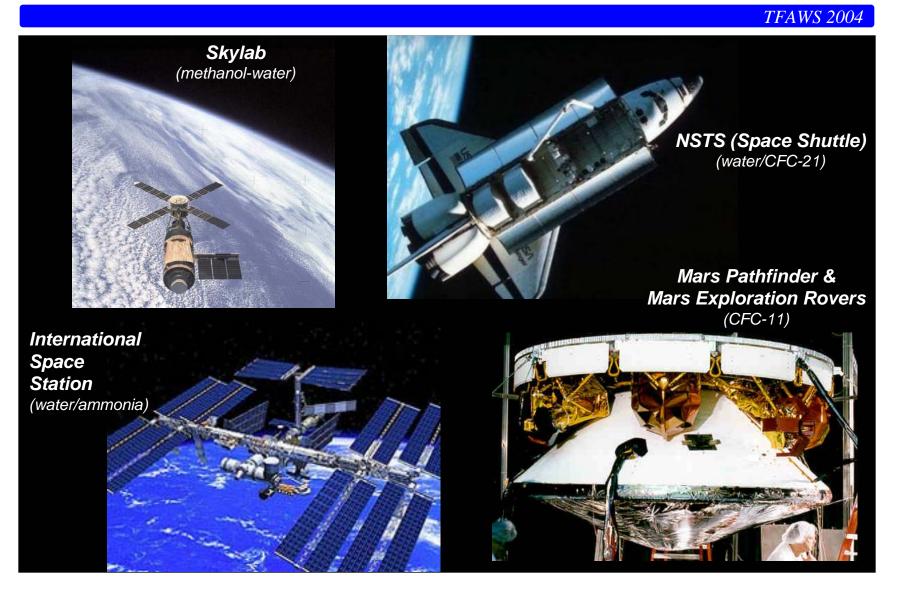


Pump
 Assembly



Mechanically Pumped Fluid Loops on NASA Missions









- *TFAWS 2004*
- **Temperature Limits:** high critical temperature (> 150°C)
- System Pressure and Temperature limits
 - moderate to low vapor pressure at high temperature (< 100 psia)
- Thermo-physical Properties:
 - High specific heat lower required mass flow
 - Low viscosity lower pressure drop across pump
- **Material Properties:** Chemical compatibility, degradation of fluid over time
- **Heritage:** Space applications (NASA, Aerospace Industry), Terrestrial applications





Working Fluid	Liquid Temperature Limits (°C)	Vapor Press. @ 200°C	Specific Heat	Viscosity	Heritage
CFC-11	-111 to 180	N/A	Low	Low	MPF, MER
Water	0 to 370	225 psi	High	Low	NASA STS ISS
Therminol LT	-75 to 315	24 psi	Moderate	High	Chemical Processing Industry
Syltherm XLT	-100 to 260	3000 psi	Moderate	Very High	JPL Laboratory chillers





Water (ISS, STS), Aqueous Ethylene Glycol (Automotive), CFC-11 (MER, MPF), Therminol®59 and Syltherm®XLT (Chemical processing industries) are examples of working fluids that could be traded off

Working Fluid	Freeze Point	Vapor Press.	Specific Heat	Thermal Cond.	Dynamic Visc.
	°C	MPa	kJ/kg•K	W/m•K	mPa•s
Water	0	0.48	4.3	0.69	0.18
Ethylene Glycol, 50% Wt	-35	0.32	3.9	0.39	0.37
CFC 11	-111	2.11	1	0.05	0.16
Therminol®59	-45	0.003	2.1	0.11	0.75
Syltherm®XLT	-111	6.8	2	0.08	0.34

• Thermophysical properties are evaluated at 150°C

• Therminol®59 and Syltherm®XLT are products of Solutia, Inc. and Dow Chemical Co., respectively





- Prevention of leaks is of paramount importance!!!
 - Entire system is hermetically sealed (welded) except for few mechanical joints (10-20) for spacecraft integration

Pumps

- The prime mover of fluid
- Typically centrifugal
- Journal bearings, all welded construction
- Redundant set used for reliability
- Filter
 - Protects pump bearings from particles
 - Typically uses a check valve in parallel to bypass filter if filter saturates in flight
- Radiator
 - Rejects heat to space
 - Plate welded, glued or brazed to fluid tubing





Accumulator

- Maintains nearly constant pressure in system throughout mission
- Gas charged with bellows separating gas from fluid

Check Valves

- Isolate redundant pump from flow path
- Bypass particle filter, if it gets saturated
- Tubing
 - Aluminum (for heat transfer)
 - · Used in heat transfer areas
 - > Heat pickup and rejection
 - · Lighter
 - Stainless Steel (for transport of fluid)
 - · Non-heat transfer areas
 - Maximum compatibility with working fluids
 - · Heavier





- Single most important part of the design of pumped fluid loop is the prevention of leaks!
 - Leaks of sizes larger than accumulator is sized for would be catastrophic
 - Could lead to mission failure
- System is of a welded construction as much as possible
- Mechanical joints used sparingly only when integration requires them
 - Keep number of mechanical joints less than 10 20
- Size Accumulator to accommodate nominal leak rates
- Use highest quality leak wise mechanical joints
- Attractive Mechanical Joints
 - Swagelock VCR
 - Omnisafe (Swagelock like design with no torque on joint)
 - Ring Seals (O-Rings on A-N)
 - A-N (B-Nuts)
- Take mechanical joints out of load paths
 - Provide stress relief bends in tubing near joints
 - Brace joints by splines
- Qualify, Qualify, Qualify
 - Thermal and Vibrational
 - Leak tests





- Long term compatibility of materials in wetted path paramount
- Typically designed to last 1 to 3 years of more
- Stainless steels (e.g., 316 L) are very attractive
 - Extremely low moisture content in Freon-11 systems is very critical
 - Typically < 10 ppm desirable
 - · 100 ppm (saturation) leads to extensive corrosion
- Aluminum is attractive from thermal and mass standpoint
 - But not as compatible as SS
 - Low moisture content is critical
- For water based fluid systems, ultra pure (DI) water very desirable
 - Some anti-corrosion additives would inhibit corrosion
 - · But would require trade-off with thermo-fluid properties
- Motor/Pump material list to be carefully examined to ensure extreme compatibility with working fluid





- Thermal-Hydraulic
 - Simulate Electronic Shelf & Radiator To Validate Thermal And Hydraulic Performance Models
 - Excellent Agreement, Conservative
- Leaks:
 - Simulate Thermal Cycling & Launch Flexing Of "A-N" Fittings ("B-Nuts") To Investigate Leak Potential -- Leak Rates Very Low (< 10-4 scc/s He)
 - Measure Leak Rate Of Freon Through Teflon Flex Lines -- Small Leak Rate
 - Accumulator Size Adequate To Accommodate Measured Leak Rates

• Material Compatibility:

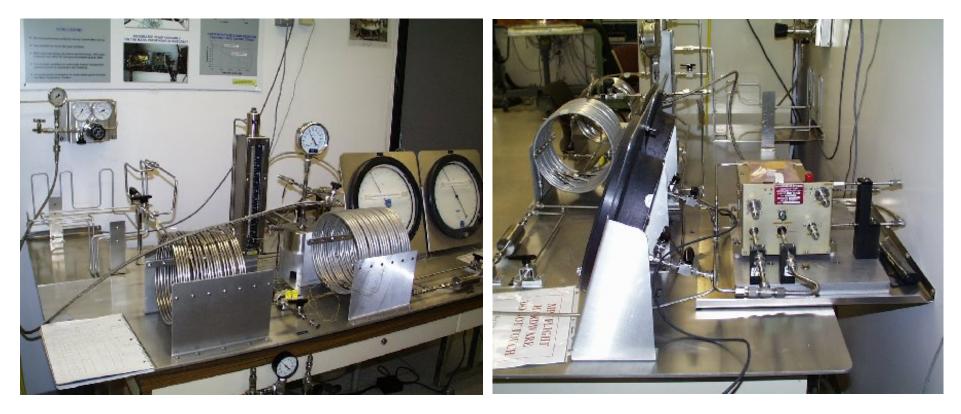
- Freon Moisture Tests
- All Materials In Contact With Freon Undergoing Long Term Compatibility Tests With Varying Levels Of Moisture (AI, SS, VITON, etc.)
- Extremely Important To Minimize Moisture To Prevent Corrosion; Elaborate Safeguards Taken In Freon Storage & Loading Process



Δ P/Flow Design Verification for MER



Hydrodynamic Test Setup at Integrated Pump Assembly Level



Front View of Test Stand

Side View of Test Stand





Simulate Long Term Operation

- (5000 Hours Flight Duration, 7 Months) Of Pump Assembly & Particle Filter, In Conjunction With Rest Of HRS (AI, SS, Teflon Tubing, Accumulator, Etc.)
- 7300 Hours (10 Months) Of Uninterrupted Operation
- No Pump Failures
- Filter Used In Mock-up Had Inadequate Capacity & Was Bypassed (Flight Filter At Least 5x Higher Capacity)
 - Flight Filter Uses Check Valve For Bypass
- Simulate & Measure Long Term Corrosion
 - On HRS Tubing (AI, SS)
 - Samples Of Tubing & Freon Liquid Taken Out Periodically For Analysis
 - No Evidence Of Corrosion Found
- Measure Long Term Leaks From HRS
 - Particularly Due To Mechanical Joints ("A-N" Fittings or "B-Nuts")
 - Relatively Large Leaks Observed In The Beginning Of Test Which Were Corrected And Prompted A More Elaborate Leak Test Done Separately





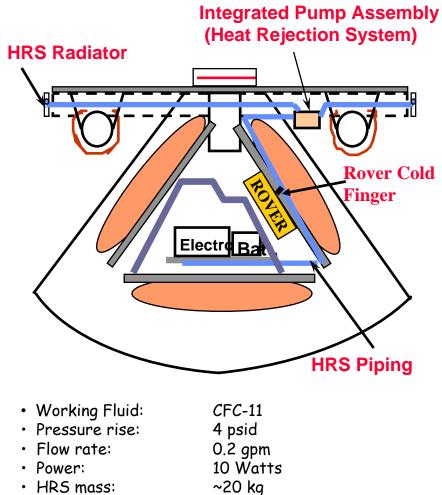
- Venting
 - If fluid loop used in cruise but not for surface operations (MER/MPF)
 - Venting of working fluid required prior to cruise stage separation
 - Controlled vent required to minimize torque and impulse (nutation) on S/C
 - Pyro-actuated valve allows accumulator gas to push out liquid though pyro-actuated valve to space
 - Nozzle axis lies on S/C c.g (MPF)
 - > Nutation exceeded estimates
 - Nozzle axis lies along S/C axis (MER)
 - > Nutation close to estimates
 - > Desirable scheme
 - Vent in a "bottle" could avoid torque/impulse by not venting to space
 - Has not been implemented, but would be an attractive option
 - Particularly suited for fluid that could freeze up a nozzle (e.g., H2O, high freezing point)



Case Study: Mars Pathfinder, MPF (*Past*)

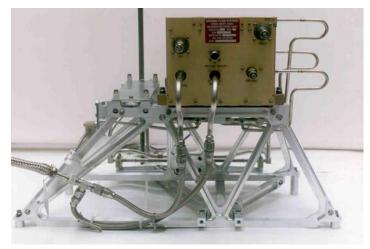






• Heat rejected: 150 Watts

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MPF HRS Pump Assembly





MPF Centrifugal Pump





• Journal Bearings (Hydrodynamically Lubricated)

• 12,000 rpm

• 250 g

All Stainless Steel construction

Permanent Magnet
 embedded in Rotor

• Hall Sensors and rotating magnetic field in Stator

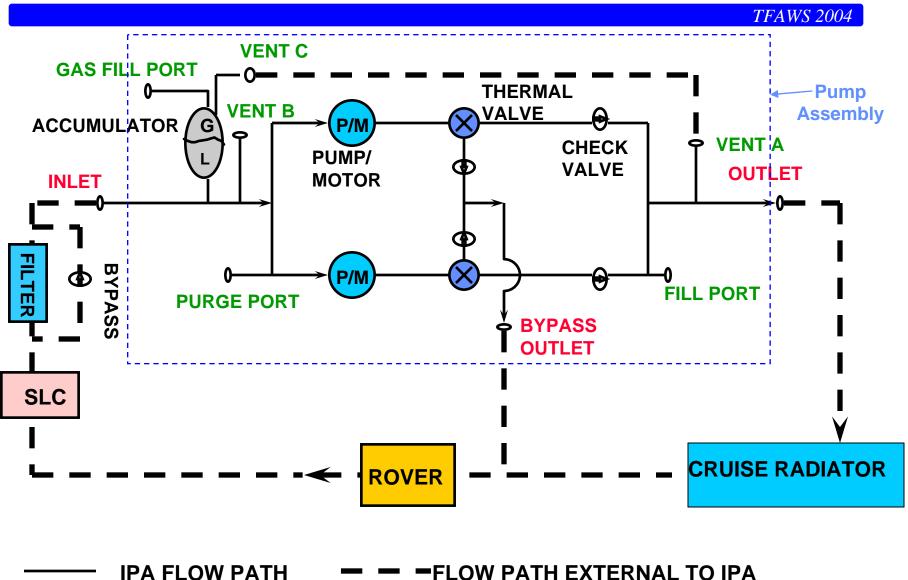
 Pacific design Technologies Manufacturer

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MPF Pumped Cooling Loop Schematic



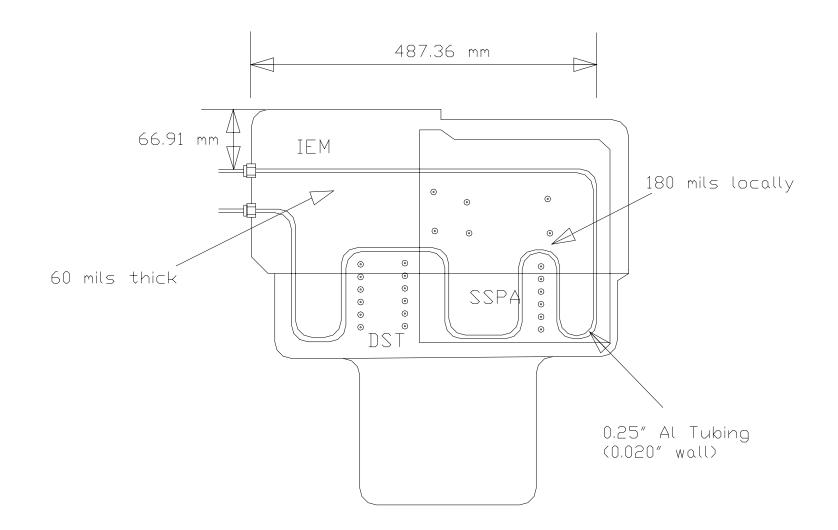


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MPF Tubing Layout To Pick Up Heat From Electronics Shelf









- Pumped liquid (Freon-11) cooling system to maintain electronics temp. within insulated enclosure - 7 months mission
- 90 to 150 W cooling load
- -60 to -20 °C (low); 5 to 70 °C (high) ... temp. limits of components
- 0.2 gpm flow; 4 psid pressure rise
- 1/4" and 3/8" aluminum and SS tubing
- tubing brazed to aluminum face-sheet on which electronics is mounted
- tubing strategically routed near high heat flux areas
- 27' x 8" x 0.030" aluminum radiator
- white paint on both sides of radiator
 - conductively decoupled from cruise stage
 - radiatively coupled to cruise stage (to prevent freon freezing during very cold cases) 93% of freon flow bypasses radiator in coldest cases





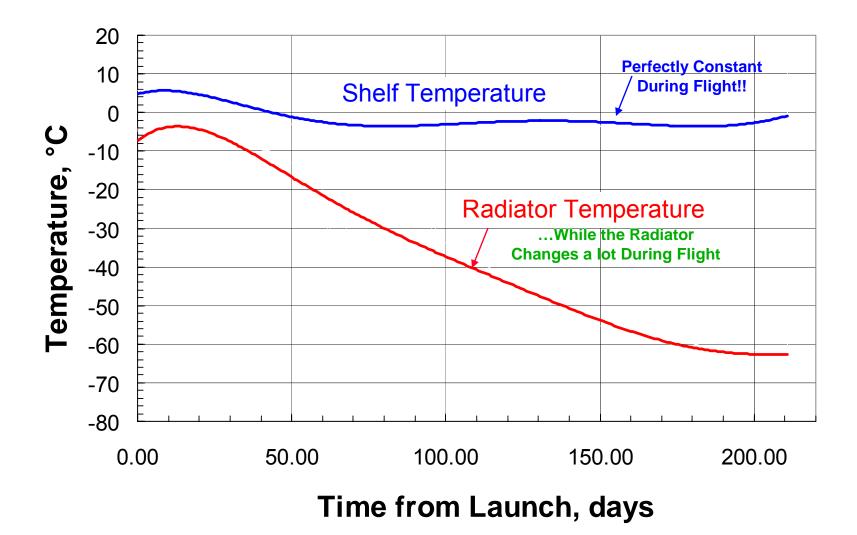


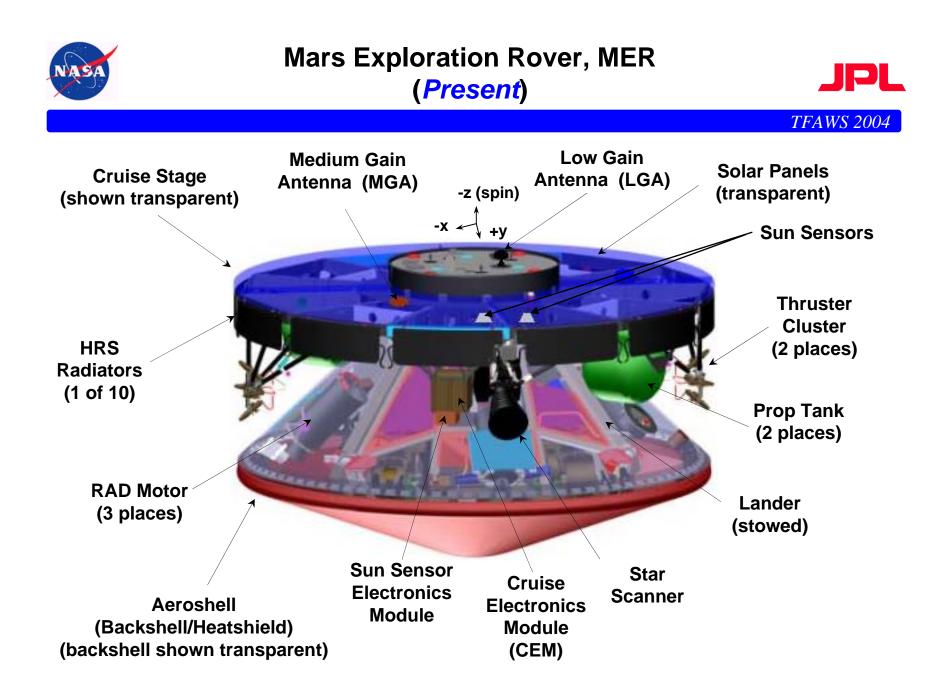
- Bench testing done after preliminary back of the envelope design, to test thermal and hydraulic characteristics
 - measured pressure drop within 10% of predicts
 - difference between electronic temp. predicts and test < 5 °C
- Detailed design performed on entire s/c later
- Solar Thermal Vac (STV) test followed detailed design
- Generally speaking, the preliminary back of envelope design calcs. for the HRS were verified by detailed design and STV (within 5 to 10 °C)
- Pathfinder flight data shows that system was working excellently as predicted by the initial back of the envelope design calculations



MPF Electronics Shelf Temperature During Flight



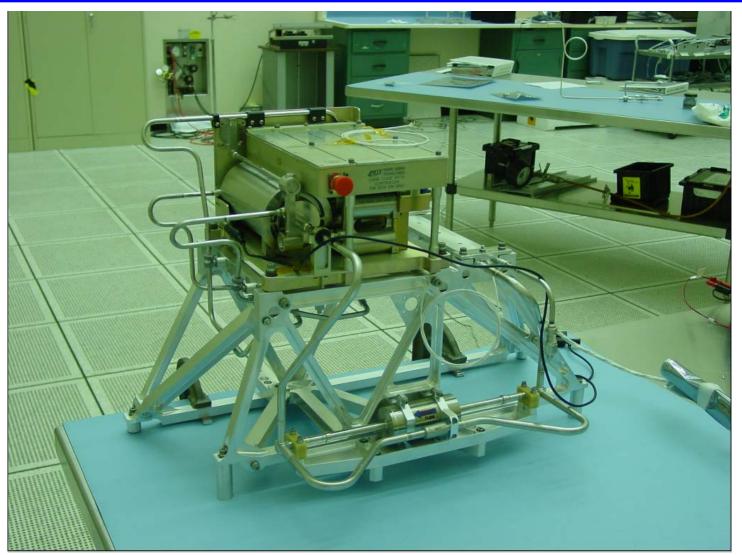






MER Pump Assembly & Associated Support Structure

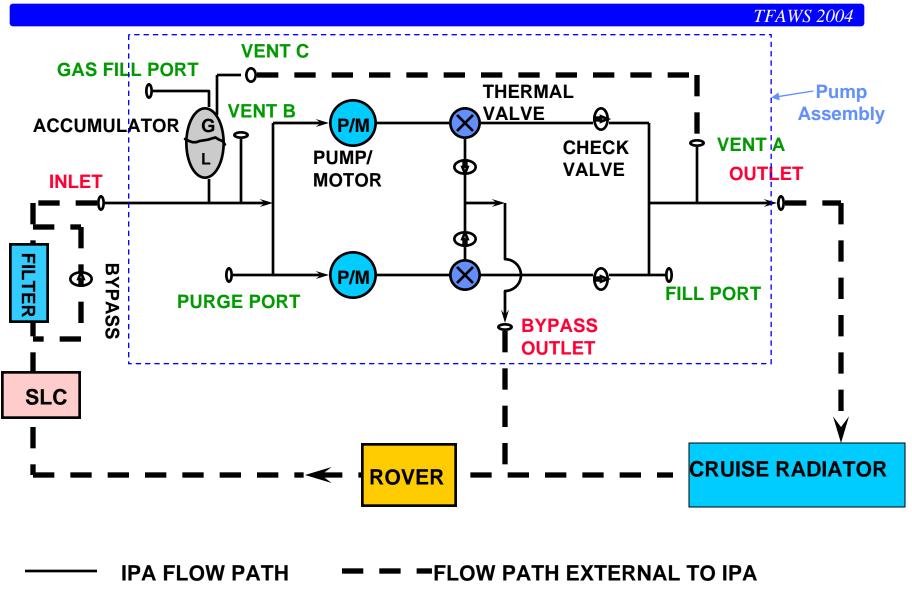






MER Pumped Loop Schematic

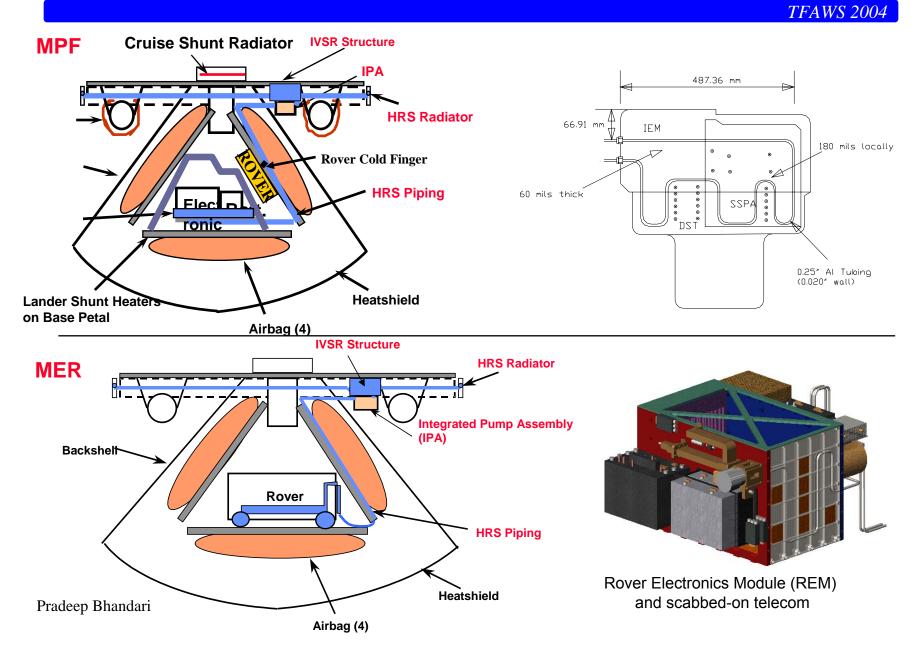






MPF vs MER Layout









- Primary driver was to keep Pump Assembly design invariant
- Higher heat fluxes from electronics
- Different tube routing and dimensions
- Vent redesign
 - Along S/C spin axis (MPF had it aligned along S/C c.g.)



Pump Assembly Installation on MER Spacecraft





IVSR being installed on Crsuie Stage



View of IVSR and 'shark' fin on Cruise Shunt LImiter

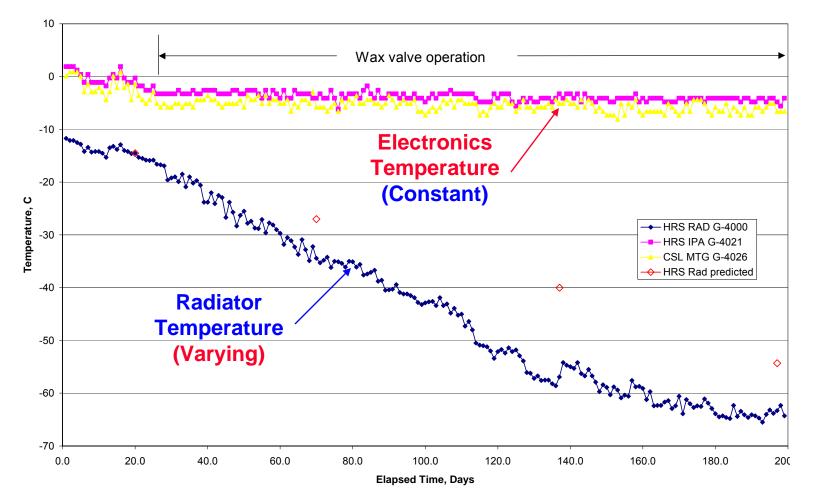


MER Flight Results: Radiator, IPA Temperatures



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MER-B Flight Data





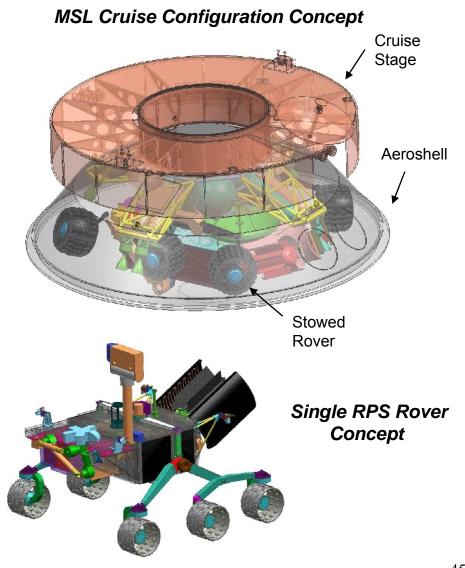
NASA Mars Science Laboratory Mission (2009) (*Future*)





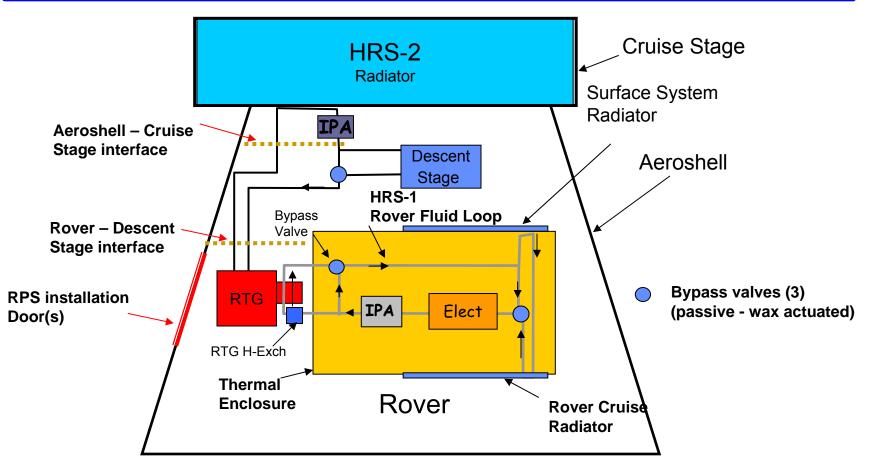
- MSL is a landed rover mission similar to Mars Exploration Rover (MER) Missions
- Power source for the MSL Rover will likely be Radioisotope Power Sources (RPS) instead of solar arrays
- Rover electronics and RPS will be stowed within an insulated aeroshell enclosure
- MSL duration may be 2x- 4x that of MER
 - 9 month cruise, 1 year surface operation

Dual RPS Rover Concept





MSL Fluid Loops (2) for Cruise & Surface



- The surface HRS system (HRS-1) uses CFC-11 as the working fluid and has an operating temperature range of -100 to +70 C in various components of the system
- Cruise HRS (HRS-2) uses either water (in the +30 to 120 C range) or CFC-11 (in the 0 to 100 C range)
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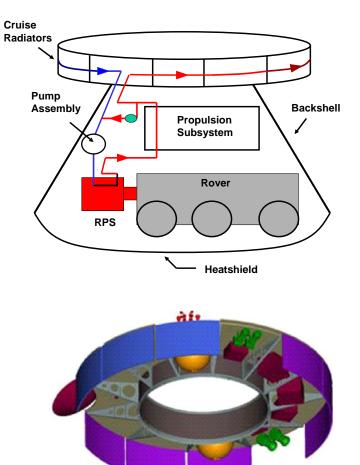
MPFL RPS Heat Rejection System for MSL (Cruise)



• An MPFL may be used to pick up heat from the RPS surface and reject it at external radiators during *cruise* to Mars

• Working fluid in the MPFL can have a temperature near the max allowable flight temperature of the RPS units (up to 200°C)

• A MPFL designed for high temperatures (100 to 150°C) would allow for smaller and less massive radiators on the cruise stage and eliminate the need for subcooling the RPS

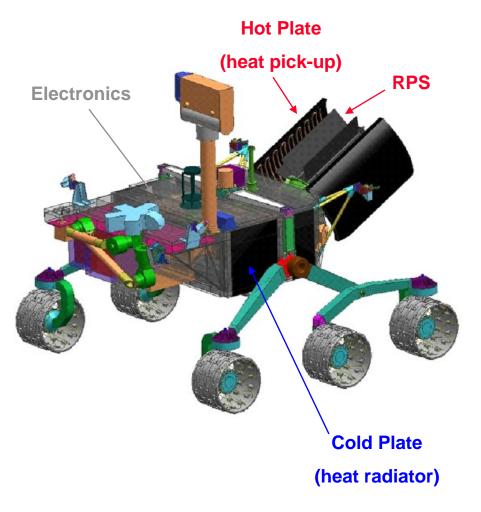




MPFL Rover Thermal Bus for MSL (Surface)



- For thermal control of the rover during Surface
 Operations
 - For both heating and cooling
 - Harvests up waste heat from the RTG for cold conditions
 - Uses radiators to maintain rovers temperatures during hot conditions
- 1st instance of using pumped fluid loop as a <u>Thermal Bus</u> to supply as well as pick-up heat from electronics







• NASA/JPL (Mars Technology Program) would like to develop Mechanically Pumped Fluid Loop heat rejection technology for the next generation of Mars Missions

• Flight Heritage MPFLs used on Mars Pathfinder and Mars Exploration Rover missions is insufficient for rejecting large heat loads or operating at high temperatures

• A new high temperature MPFL design for future robotic missions will be investigated:

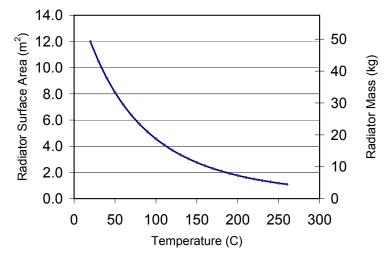
- Design to system constraints
- Select optimal working fluid for the MPFL
- Begin development testing to investigate pump performance and material compatibility in a high temperature environment







Operation of a MPFL at elevated temperatures allows for reduced radiator area and waste heat utilization



Variation in Radiator Size and Mass with Temperature (assumes 4000 W of heat rejection with no solar loading)

- A high temperature, single-phase MPFL has advantages over a heat pump system (simplicity, reliability, etc.) but requires a high temperature heat source
- Temperatures of some heat sources can be as high as 200°C
 - Radioisotope Power Sources
 - Laser-based Instrumentation
- High temperature rated electronics





- Identify specifications for loop components (pump, tubing, accumulator, etc)
 - High Temp Pump (Engineering model)
 - Stainless steel/Aluminum Loop material
- Performance/functional testing of components at elevated temperature
 - Pump Testbed Facility
- Material compatibility studies at temperature
 - Stainless steel, aluminum, water test samples

Engineering Model Pump



Pacific Design Technologies, Inc. (Goleta, CA)

- Designed for water service at 130°C
- Maximum flow rate of 1.5 lpm with 140 kPa (20 psid) pressure rise
- 300 Series Stainless Steel construction
- O-ring seals allow pump to be disassembled and inspected

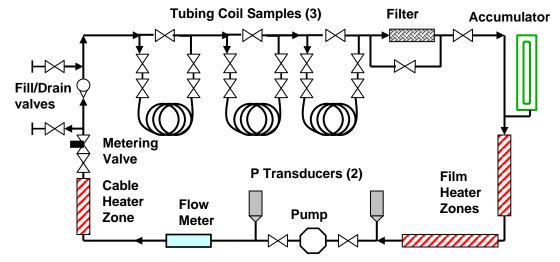


High Temperature Pump Testbed





- Designed to maintain pump and water at 120°C
- System pressure of approximately 100 psia (0.7 MPa)
- Wetted Flow path: 300 series stainless steel
- Filled with Nanopure water (initial resistivity > 18 MOhmcm)
- In-line filter removes particles
 greater than 25 microns
- Thermocouples monitor loop temperatures, pressure transducers monitor pressure drops







Material Compatibility Coupon Tests



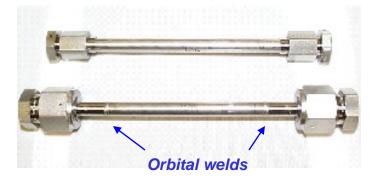


• Stainless steel and Aluminum tubing samples have been fabricated and filled with Nanopure water

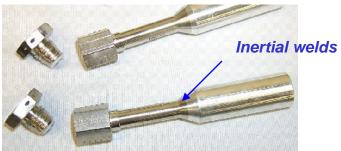
• Sample types include stainless steel and aluminum orbital welds, stainless steel to aluminum inertial welds, and aluminum coupons within stainless steel tubing.

 \bullet Samples are sealed and baked in a 150°C oven

• A member of each sample type will be opened and inspected at 30 day intervals







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These Could Potentially Reduce Power/Mass While Improving Performance And Reliability

- Thermal Bus
 - Clever use of bypass valves, employ loop as a thermal bus to "pick up" heat from unwanted locations (e.g., solar array) and insert in locations needing heat for t/c (e.g., electronics)
 - Reduce heater power requirements for cold phases of missions
- Temperature Modulation
 - Different temperature modulation schemes (variable speed pump)
 - Smaller power usage of pumps
- Better Accumulators
 - Development of accumulators which can accommodate gas leaks
 - Reduce mass/size of accumulators
- Different Operating Fluids
 - More optimized to specific system requirements
- Two Phase Loops
 - Reduce mass/size of loops for large heat loads





- The research described in this paper was performed at the Jet Propulsion Laboratory, California Institute of Technology, under a contract with the National Aeronautics and Space Administration
- The following is a subset of many folks at JPL who have contributed to the successful development and implementation of this technology
 - Andre Yavrouian (Chemistry)
 - Jack Patzold (Implementation)
 - Paul McGrath (Pump Contract Manager)
 - Dave Bame (Implementation)
 - Partha Shakkottai (Venting Analysis)
- Pacific Design Technology for designing, manufacturing and supplying the pump assembly





- Active heat rejection systems consisting of mechanically pumped single-phase liquid were designed and developed for Mars Pathfinder (MPF) and the two Mars Exploration Rover Missions
- The successful flight demonstration (3 out of 3) of these mechanically pumped cooling loops in these missions has shown that active cooling systems can be reliably used in deep space missions
- The Mars Science Laboratory (MSL) Mission (2009 launch) has base-lined two mechanically pumped fluid loop systems
 - One for cruise to cool the RTG, one for thermal control of the rover
 - The rover loop is a true thermal bus
 - To achieve thermal control of the rover, it simultaneously picks up heat from the RTG and rejects excess heat to radiator
- The next generation of loops would extend the state of the art to higher heat rates and fluxes by using two-phase flow, lighter accumulators and more choices of working fluids to make them true thermal buses
- The flexibility provided by mechanically pumped fluid thermal control systems in the design, integration, test, and flight operation of spacecraft makes this thermal control system a very attractive and reliable system for future missions



